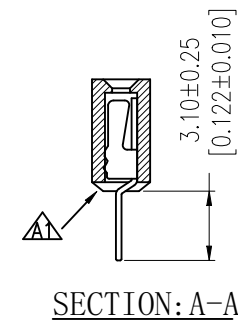
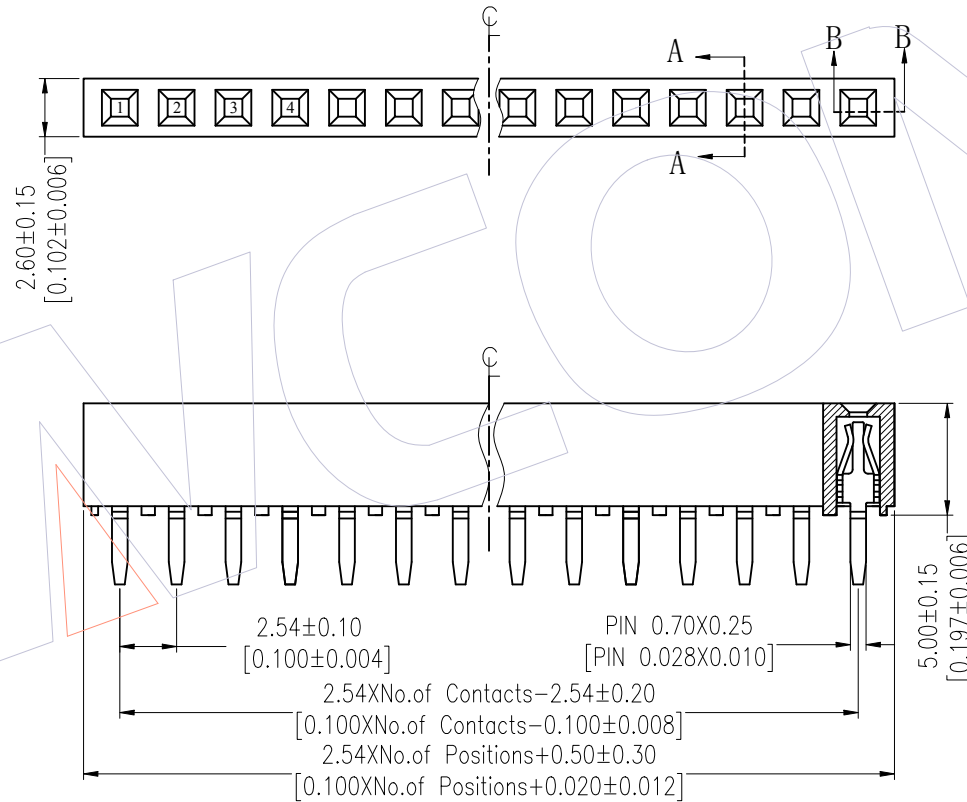
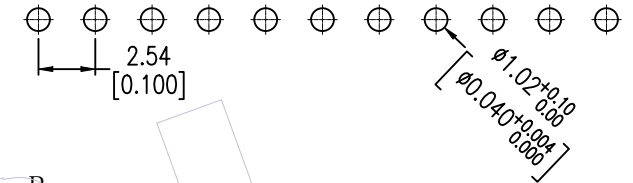


HSF

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

NOTES:
 Current Rating: 3.0AMP
 Contact Resistance: 20mΩ Max
 Withstand Voltage: 1000V AC/DC
 Insulation Resistance: 1000MΩ Min
 Operation Temperature: -40°C to +105°C

Contact Material:Phosphor Bronze
 Contact plating:Au Or Sn over Ni
 Insulator Material:PA9T+30%G.F UL94V-0



Ordering Information

2150 - 1 XX S XX XUNT 1

- No. of Pins per ROW:02-40PIN
- Contact Plating:
 G0=Gold Flash
 G3=10μ"Gold
 G4=15μ"Gold
 G5=30μ"Gold
 S0=Gold Flash/Tin
 S3=10μ"Gold/Tin
 S4=15μ"Gold/Tin
 S5=30μ"Gold/Tin
 SN=Tin
 SM=Matte Tin
- Insulator :
 C=PA9T
- Packing:
 T=Tube

Item	Pitch	Mating
Standard	2.54	1115/1120/1125
Alternate		

SECTION: B-B

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	OPERATION	DRAW	DATE	SCALE	FIT	PART NO.
				X.X ±0.40	Wang	2014/05/03	UNIT mm		2150-1XXSXXXUNT1
A1	2014/05/03	Modify drawing	-----	X.XX ±0.25	CHECK	DATE	SIZE A4		TITLE: FH2.54 SINGLE ROW 180° DIP H=5.0
A0	2012/08/04	NEW	-----	X.XXX ±0.15			SHEET 1/1		
				Angle ± 3°	APPROVE	DATE	PROJ.		Customer NO.
				DIM TOL					

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